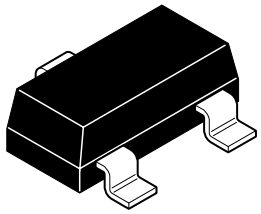
ZXTN25100DFH
100V, SOT23, NPN medium power transistor

Summary



BV_{CEX} > 180V

BV_{CEO} > 100V

BV_{ECO} > 6V

$I_{C(cont)}$ = 2.5A

$V_{CE(sat)}$ < 95mV @ 1A

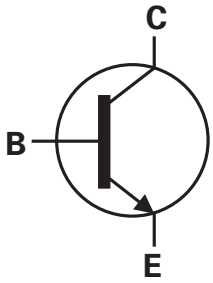
$R_{CE(sat)}$ = 86mΩ

P_D = 1.25W

Complementary part number ZXTP25100DFH

Description

Advanced process capability and package design have been used to maximise the power handling and performance of this small outline transistor. The compact size and ratings of this device make it ideally suited to applications where space is at a premium.

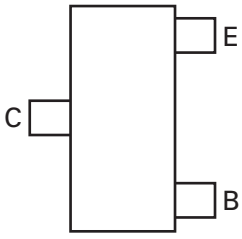


Features

- High power dissipation SOT23 package
- High gain
- Low saturation voltage
- 180V forward blocking voltage
- 6V reverse blocking voltage

Application

- Motor control
- DC fans
- DC-DC converters
- Lamp, relay, and solenoid driving



Pinout - top view

Ordering information

Device	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN25100DFHTA	7	8	3,000

Device marking

1B5

Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Collector-base voltage	V_{CBO}	180	V
Collector-emitter voltage (forward blocking)	V_{CEX}	180	V
Collector-emitter voltage	V_{CEO}	100	V
Emitter-collector voltage (reverse blocking)	V_{ECO}	6	V
Emitter-base voltage	V_{EBO}	7	V
Continuous collector current[c]	I_C	2.5	A
Base current	I_B	0.5	A
Peak pulse current	I_{CM}	3	A
Power dissipation at T_{amb} =25°C[a]	P_D	0.73	W
Linear derating factor		5.84	mW/°C
Power dissipation at T_{amb} =25°C[b]	P_D	1.05	W
Linear derating factor		8.4	mW/°C
Power dissipation at T_{amb} =25°C[c]	P_D	1.25	W
Linear derating factor		9.6	mW/°C
Power dissipation at T_{amb} =25°C[d]	P_D	1.81	W
Linear derating factor		14.5	mW/°C
Operating and storage temperature range	T_j, T_{stg}	- 55 to 150	°C

Thermal resistance

Parameter	Symbol	Limit	Unit
Junction to ambient[a]	$R_{\Theta JA}$	171	°C/W
Junction to ambient[b]	$R_{\Theta JA}$	119	°C/W
Junction to ambient[c]	$R_{\Theta JA}$	100	°C/W
Junction to ambient[d]	$R_{\Theta JA}$	69	°C/W

NOTES:

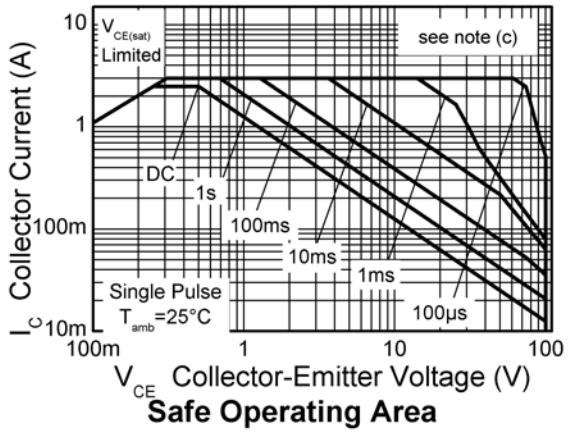
(a) For a device surface mounted on 15mm x 15mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

(b) Mounted on 25mm x 25mm x 1.6mm FR4 PCB with a high coverage of single sided 2 oz copper in still air conditions.

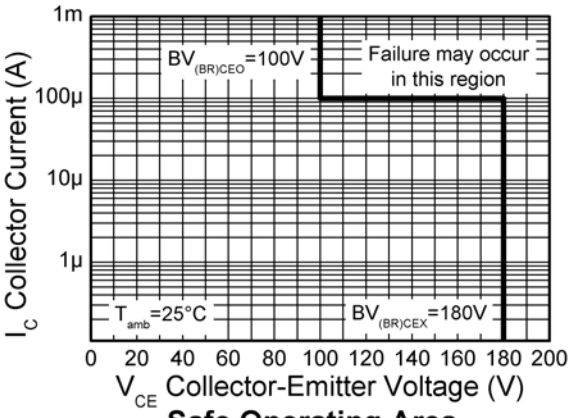
(c) Mounted on 50mm x 50mm x 1.6mm FR4 PCB with a high coverage of single sided 2 oz copper in still air conditions.

(d) As (c) above measured at t<5secs.

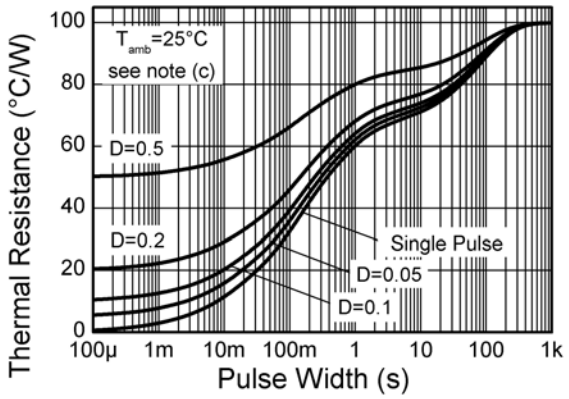
Characteristics



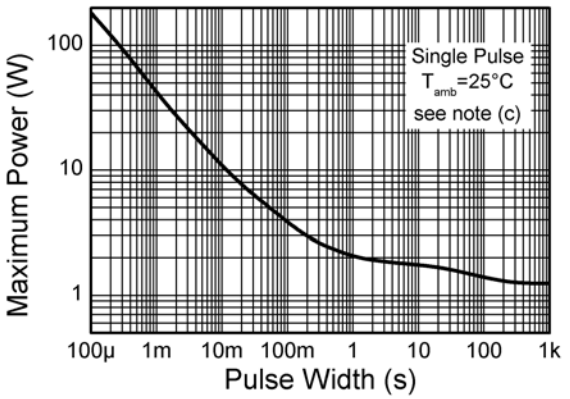
Safe Operating Area



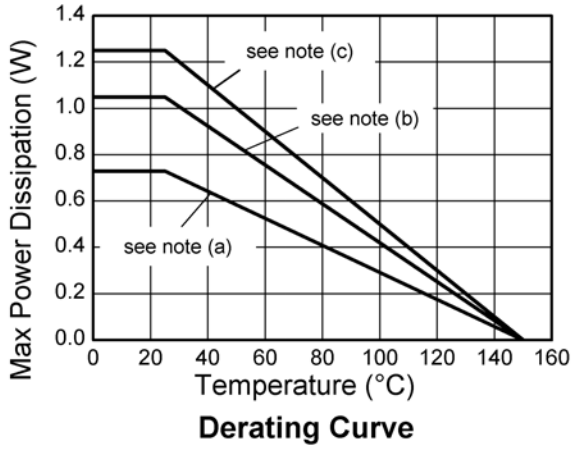
Safe Operating Area



Transient Thermal Impedance



Pulse Power Dissipation



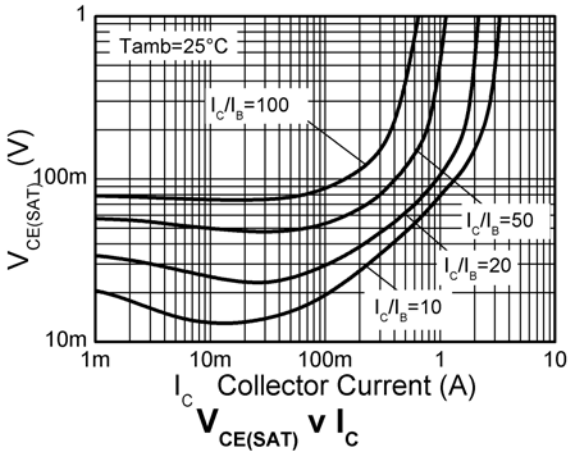
Derating Curve

Electrical characteristics (at T_{amb} = 25°C unless otherwise stated)

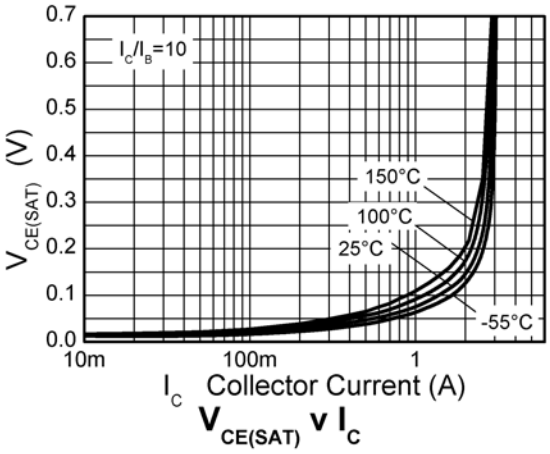
Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Collector-base breakdown voltage	BV_{CBO}	180	220		V	I_C = 100μA
Collector-emitter breakdown voltage (forward blocking)	BV_{CEX}	180	220		V	I_C = 100μA, $R_{BE} \leq$ 1kΩ or -1V < V_{BE} < 0.25V
Collector-emitter breakdown voltage (base open)	BV_{CEO}	100	130		V	I_C = 10mA (*)
Emitter-base breakdown voltage	BV_{EBO}	7	8.3		V	I_E = 100μA
Emitter-collector breakdown voltage (reverse blocking)	BV_{ECX}	6	8.2		V	I_E = 100μA, $R_{BC} \leq$ 1kΩ or 0.25V > V_{BC} > -0.25V
Emitter-collector breakdown voltage (base open)	BV_{ECO}	6	8.7		V	I_E = 100μA,
Collector-base cut-off current	I_{CBO}		<1	50 20	nA μA	V_{CB} = 144V V_{CB} = 144V, T_{amb}= 100°C
Collector-emitter cut-off current	I_{CEX}		-	100	nA	V_{CE} = 144V; $R_{BE} \leq$ 1kΩ or -1V < V_{BE} < 0.25V
Emitter-base cut-off current	I_{EBO}		<1	50	nA	V_{EB} = 5.6V
Collector-emitter saturation voltage	$V_{CE(sat)}$		120 80 215	170 95 330	mV mV mV	I_C = 0.5A, I_B = 10mA(*) I_C = 1A, I_B = 100mA(*) I_C = 2.5A, I_B = 250mA(*)
Base-emitter saturation voltage	$V_{BE(sat)}$		910	1000	mV	I_C = 2.5A, I_B = 250mA(*)
Base-emitter turn-on voltage	$V_{BE(on)}$		860	950	mV	I_C = 2.5A, V_{CE} = 2V(*)
Static forward current transfer ratio	h_{FE}	300 120 40	450 170 60 20	900		I_C = 10mA, V_{CE} = 2V(*) I_C = 0.5A, V_{CE} = 2V(*) I_C = 1A, V_{CE} = 2V(*) I_C = 2.5A, V_{CE} = 2V(*)
Transition frequency	f_T		175		MHz	I_C = 100mA, V_{CE} = 10V f = 100MHz
Output capacitance	C_{OBO}		8.7	15	pF	V_{CB} = 10V, f = 1MHz(*)
Delay time	t_d		16.4		ns	V_{CC} = 10V. I_C = 500mA, I_{B1} = I_{B2}= 50mA.
Rise time	t_r		115		ns	
Storage time	t_s		763		ns	
Fall time	t_f		158		ns	

NOTES:
(*) Measured under pulsed conditions. Pulse width ≤300μs; duty cycle ≤2%.

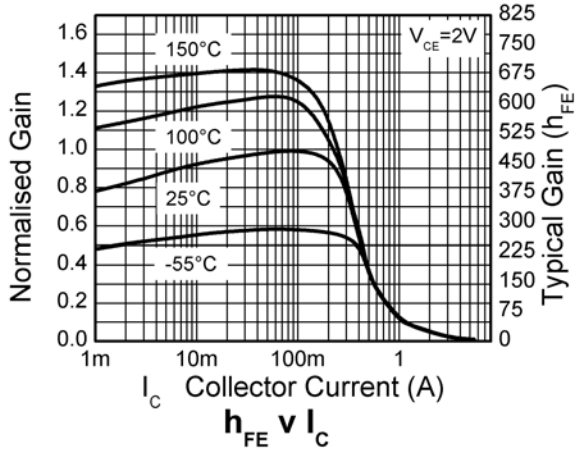
Typical characteristics



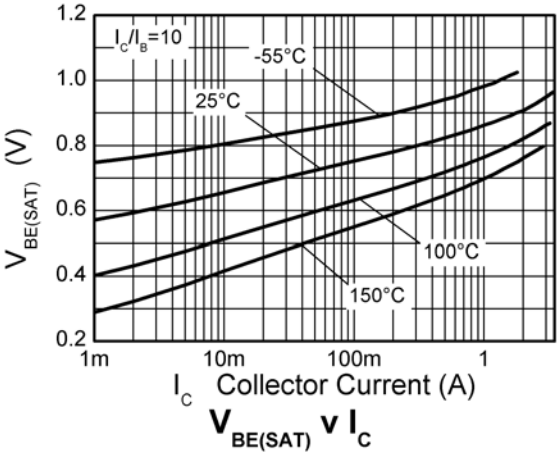
$V_{CE(SAT)}$ v I_C



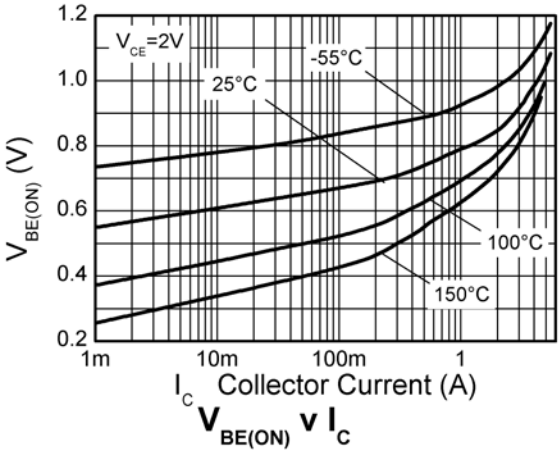
$V_{CE(SAT)}$ v I_C



h_{FE} v I_C

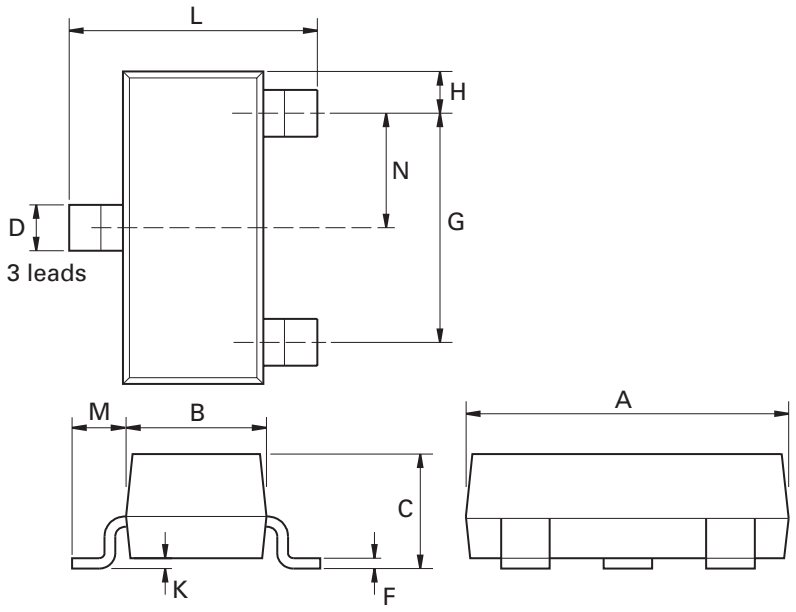


$V_{BE(SAT)}$ v I_C



$V_{BE(ON)}$ v I_C

Package outline - SOT23



Dim.	Millimeters		Inches		Dim.	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Max.	Max.
A	2.67	3.05	0.105	0.120	H	0.33	0.51	0.013	0.020
B	1.20	1.40	0.047	0.055	K	0.01	0.10	0.0004	0.004
C	-	1.10	-	0.043	L	2.10	2.50	0.083	0.0985
D	0.37	0.53	0.015	0.021	M	0.45	0.64	0.018	0.025
F	0.085	0.15	0.0034	0.0059	N	0.95 NOM		0.0375 NOM	
G	1.90 NOM		0.075 NOM		-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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